## NSN 5962-01-128-4693



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-01-128-4693 **Body Length:** 1.425 inches **Body Width:** Between 0.510 inches and 0.550 inches **Body Height:** Between 0.100 inches and 0.180 inches **Maximum Power Dissipation Rating:** 600.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **End Application:** Inflight test 76301 **Features Provided:** Hermetically sealed and w/clock and electrically alterable and w/strobe and w/disable **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 25 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 30.0 volts power source **Memory Device Type:** Rom **Test Data Document:** 19133-4350066 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 28 printed circuit Shelf Life: N/a **Unit Of Measure:** 

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**Demilitarization:** Yes - demil/mli